Abstract

A semiconductor memory component such as a maskprogrammable ROM component, has two memory cell

transistors adjacent to each other in one column of a
memory cell field. First and a second rowselect/potential-equalization lines are equidistant
from the two memory cell transistors and vertically
above a diffusion region, which is assigned to both
memory cell transistors. The first or the second rowselect/potential-equalization line can be connected
both to the word line of the first memory cell
transistor and to the word line of the memory cell
transistor of the second memory cell for equalizing the
potential with one of the two word lines.